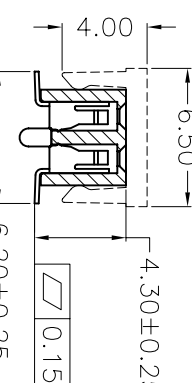
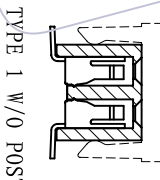
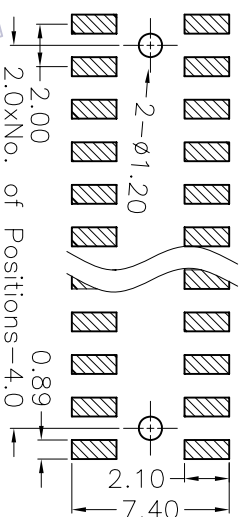
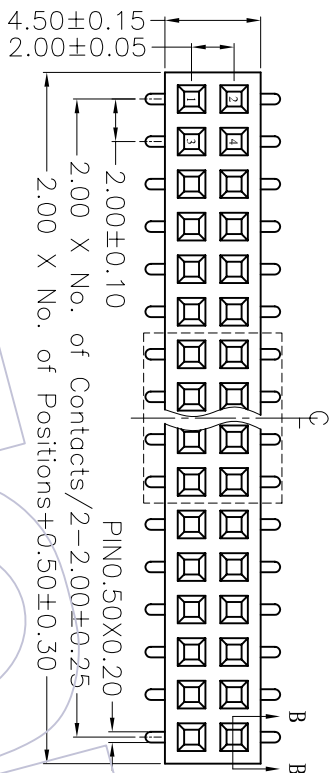


# HSP

**NOTES:**

Current Rating: 2.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩMin  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G.F UL94V-0



## Ordering Information

2240 - 2 XX M XX CUNT X

No. of Pins per ROW: 42-40PIN

Contact Plating: Au or Sn over Ni

Gold Flash: T=Tube

3μ" Gold: R=Tube&Reel+CAP

10μ" Gold: P=Tube+CAP

30μ" Gold: G=1μ"Gold

50μ" Gold: GS=30μ"Gold

Gold Flash/Tin: S0=Gold Flash/Tin

Gold/Tin: S1=3μ"Gold/Tin

Gold/Tin: S2=5μ"Gold/Tin

Gold/Tin: S3=10μ"Gold/Tin

Gold/Tin: S4=5μ"Gold/Tin

Gold/Tin: S5=30μ"Gold/Tin

Tin: SN=1μ"Tin

SECTION B-B

SECTION A-A

TYPE	PART NO.
TYPE 1	2240-2XXMXXCUNT1
TYPE 2	2240-2XXMXXCUNT2

**WCON** 维峰五金电子有限公司  
 WAFER HARDWARE ELECTRONICS CO. LTD

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/28	NEW			XXX ±0.40 XXX ±0.25 XXX ±0.15 Angle ± 3'	MeiLing 08.02.28	3:1 mm A4		PH2.00mm DUAL SWT H=4.00
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM	TOL	APPROVE	PROJ.	Customer NO.